PATENT

Docket No.: NAUP0252USA

101763845

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

RECORDING COVER SHEET

1. Assignor:

Sun-Chieh Chien, Chien-Li Kuo

2. Assignee:

UNITED MICROELECTRONICS CORP.

No.3, Li-Hsin Road 2, $\sqrt{2/\sqrt{0}}$ Science-Based Industrial Park,

Hsin-Chu, Taiwan, R.O.C.

3. Nature of Conveyance: Assignment of patent

4. Reference number:

Application filed herewith.

Correspondence to:

Winston Hsu

5F, No. 389, Fu-Ho Rd.,

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09/885049

6. Number of applications affected by this recording: 1

Total fee: $(1 \times \$ 40) = \$ 40.00$ Payment by check enclosed Authorization is hereby given to charge the over payment to deposit account #500801

- 7. Execution date of the document to be recorded: 06/06/2001
- 8. Total number of pages including cover sheet: 3
- 9. I declare under penalty of perjury that to the best of my knowledge and belief, the information contained on this cover sheet is true and correct, and that any copy submitted herewith is a true and correct copy of the original document.

Date: 6/19/2001

Winston Hau

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02 FC:581

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Winston Hsu
U.S. Patent Agent

Reg. No.:41,526

Recording Cover Sheet Page 1 of 1

PATENT REEL: 011927 FRAME: 0304

Docket No: NAUP0252USA

ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

ASSIGNORS	(Inventors):		
Name:	Sun-Chieh Chien	Nationality: R.O.C.	
Address:	No.7, Lane 30, Tun-Feng Rd., Hsiang-Shan, Hsin-Chu City, Taiwan, R.O.C.		
Name:	Chien-Li Kuo	Nationality: R.O.C.	
Address:		648, Ming-Hu Rd., Hsin-Chu City, Taiwan, R.O.C.	
(hereinafter 'As No.3, Li-Hsin), and the success interest in and to	signee'), of (Assignee ac Road 2, Science-Based sors assigns and legal re to any and all improvement	UNITED MICROELECTRONICS CORP. ddress) Industrial Park, Hsin-Chu, Taiwan, R.O.C. epresentatives of the ASSIGNEE the entire right, title, and ents which are disclosed in the invention entitled: Contact Plug in an Embedded Memory"	
Which is foun		• • • • • • • • • • • • • • • • • • • •	
(a)	U.S. patent application e	executed on even date	
		executed on	
		0	
		issued	
		obtained for said invention by the above application or an abstitute thereof, and as to letters patent any reissue or re	

it ar examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

Assignment, Page 1 of 2

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PATENT REEL: 011927 FRAME: 0305

(Type name of inventor)	Signature of INVENTOR
Sun-Chieh Chien	Sun - Chied Chia
Chien-Li Kuo	Clien -/ Kino

IN WITNESS WHEREOF, We have hereunto set hand and seal this 6.6.7 (Date of

signing).

Assignment, Page 2 of 2

RECORDED: 06/21/2001

NPO-P0002E-US1

PATENT REEL: 011927 FRAME: 0306